

DATA SHEET

74LV251

8–input multiplexer; 3–State

Product specification

1997 Apr 10

8-input multiplexer; 3-State

74LV251

FEATURES

- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between $V_{CC} = 2.7\text{ V}$ and $V_{CC} = 3.6\text{ V}$
- Typical V_{OLP} (output ground bounce) $< 0.8\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_{amb} = 25^\circ\text{C}$
- Typical V_{OHV} (output V_{OH} undershoot) $> 2\text{ V}$ at $V_{CC} = 3.3\text{ V}$, $T_{amb} = 25^\circ\text{C}$
- True and complement outputs
- Both outputs are 3-State for further multiplexer expansion
- Multifunction capability
- Permits multiplexing from n-lines to one line
- Output capability: standard
- I_{CC} category: MSI

DESCRIPTION

The 74LV251 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT251.

The 74LV251 is an 8-input multiplexer with 8 binary inputs (I_0 to I_7), an output enable input (\overline{OE}) and three select inputs (S_0, S_1, S_2). One of the eight binary inputs is selected by the select inputs and is routed to the outputs (\overline{Y}, Y). Both outputs are in the high impedance OFF-state (Z) when the output enable input is HIGH, allowing multiplexer expansion by tying the outputs.

QUICK REFERENCE DATA

$GND = 0\text{ V}$; $T_{amb} = 25^\circ\text{C}$; $t_r = t_f \leq 2.5\text{ ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t_{PHL}/t_{PLH}	Propagation delay I_n to Y I_n to \overline{Y} S_n to Y S_n to \overline{Y}	$C_L = 15\text{ pF}$; $V_{CC} = 3.3\text{ V}$	14 16 19 20	ns
C_I	Input capacitance		3.5	pF
C_{PD}	Power dissipation capacitance per gate	$V_{CC} = 3.3\text{ V}$ $V_I = GND$ to V_{CC}^1	44	pF

NOTE:

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW)
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + \sum (C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz; C_L = output load capacity in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;
 $\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

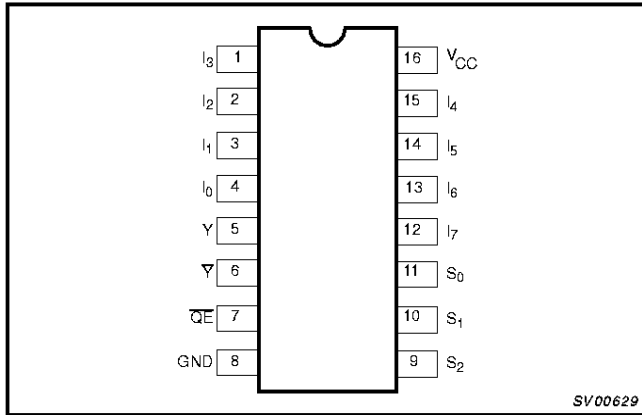
ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
16-Pin Plastic DIL	-40°C to +125°C	74LV251 N	74LV251 N	SOT38-4
16-Pin Plastic SO	-40°C to +125°C	74LV251 D	74LV251 D	SOT109-1
16-Pin Plastic SSOP Type II	-40°C to +125°C	74LV251 DB	74LV251 DB	SOT338-1
16-Pin Plastic TSSOP Type I	-40°C to +125°C	74LV251 PW	74LV251PW DH	SOT403-1

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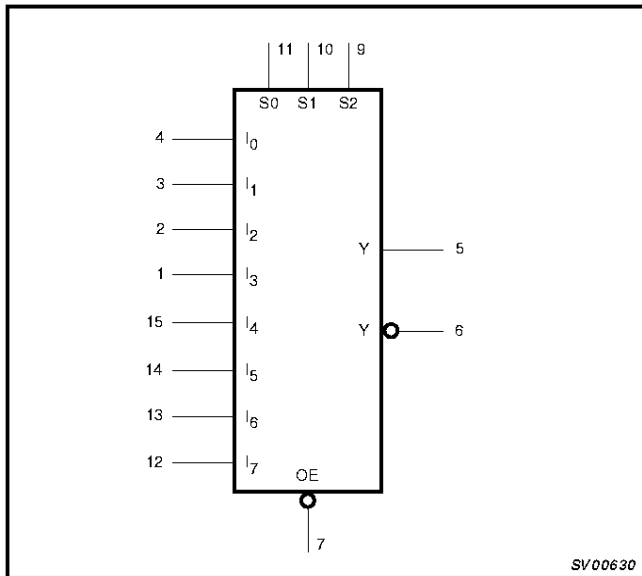
PIN CONFIGURATION



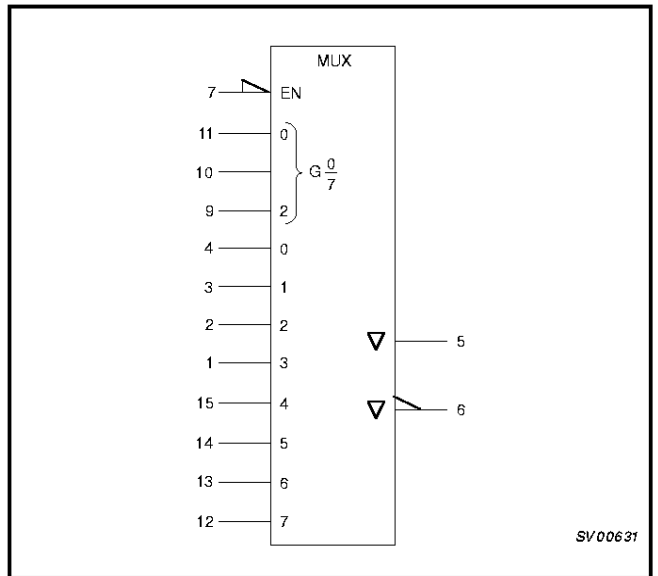
PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION
4, 3, 2, 1, 15, 14, 13, 12	I_0 to I_7	Multiplexer inputs
5	Y	Multiplexer output
6	\bar{Y}	Complementary multiplexer output
7	\overline{OE}	3-State output enable input (active LOW)
8	GND	Ground (0 V)
11, 10, 9	S_0 to S_2	Select inputs
16	V_{CC}	Positive supply voltage

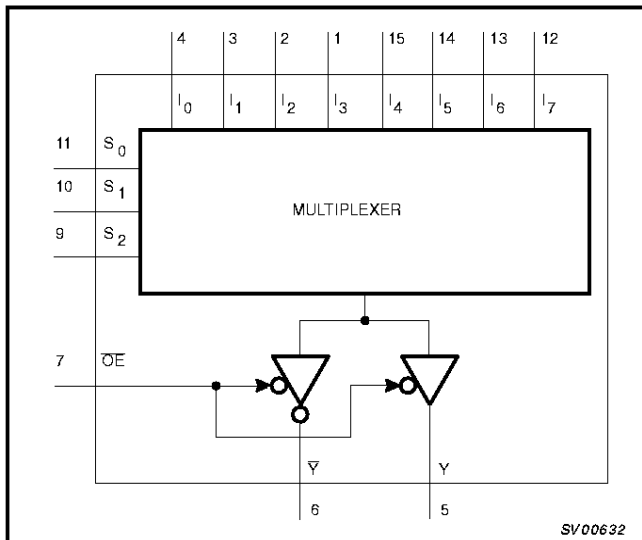
LOGIC SYMBOL



LOGIC SYMBOL (IEEE/IEC)



FUNCTIONAL DIAGRAM



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FUNCTION TABLE

INPUTS												OUTPUTS	
\overline{OE}	S_2	S_1	S_0	I_0	I_1	I_2	I_3	I_4	I_5	I_6	I_7	\overline{Y}	Y
H	X	X	X	X	X	X	X	X	X	X	X	Z	Z
L	L	L	L	L	X	X	X	X	X	X	X	H	L
L	L	L	L	H	X	X	X	X	X	X	X	L	H
L	L	L	H	X	L	X	X	X	X	X	X	H	L
L	L	L	H	X	H	X	X	X	X	X	X	L	H
L	L	H	L	X	X	L	X	X	X	X	X	H	L
L	L	H	L	X	X	H	X	X	X	X	X	L	H
L	L	H	H	X	X	X	L	X	X	X	X	H	L
L	L	H	H	X	X	X	H	X	X	X	X	L	H
L	H	L	L	X	X	X	X	L	X	X	X	H	L
L	H	L	L	X	X	X	X	H	X	X	X	L	H
L	H	L	H	X	X	X	X	X	L	X	X	H	L
L	H	L	H	X	X	X	X	X	H	X	X	L	H
L	H	H	L	X	X	X	X	X	X	L	X	H	L
L	H	H	L	X	X	X	X	X	X	H	X	L	H
L	H	H	H	X	X	X	X	X	X	X	L	H	L
L	H	H	H	X	X	X	X	X	X	X	H	L	H

NOTES:

- H = HIGH voltage level
L = LOW voltage level
X = don't care
Z = high impedance OFF-state

ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134).

Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		-0.5 to +4.6	V
$\pm I_{IK}$	DC input diode current	$V_I < -0.5$ or $V_I > V_{CC} + 0.5V$	20	mA
$\pm I_{OK}$	DC output diode current	$V_O < -0.5$ or $V_O > V_{CC} + 0.5V$	50	mA
$\pm I_O$	DC output source or sink current – standard outputs – bus driver outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25 35	mA
$\pm I_{GND}$, $\pm I_{CC}$	DC V_{CC} or GND current for types with – standard outputs – bus driver outputs		50 70	mA
T_{stg}	Storage temperature range		-65 to +150	°C
P_{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	mW

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V_{CC}	DC supply voltage	See Note 1	1.0	3.3	3.6	V
V_I	Input voltage		0	–	V_{CC}	V
V_O	Output voltage		0	–	V_{CC}	V
T_{amb}	Operating ambient temperature range in free air	See DC and AC characteristics per device	–40 –40		+85 +125	°C
t_r, t_f	Input rise and fall times except for Schmitt-trigger inputs	$V_{CC} = 1.0V$ to $2.0V$ $V_{CC} = 2.0V$ to $2.7V$ $V_{CC} = 2.7V$ to $3.6V$	– – –	– – –	500 200 100	ns/V

NOTE:

1. The LV is guaranteed to function down to $V_{CC} = 1.0V$ (input levels GND or V_{CC}); DC characteristics are guaranteed from $V_{CC} = 1.2V$ to $V_{CC} = 5.5V$.

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			–40°C to +85°C			–40°C to +125°C		
			MIN	TYP ¹	MAX	MIN	MAX	
V_{IH}	HIGH level Input voltage	$V_{CC} = 1.2V$	0.9			0.9		V
		$V_{CC} = 2.0V$	1.4			1.4		
		$V_{CC} = 2.7$ to $3.6V$	2.0			2.0		
V_{IL}	LOW level Input voltage	$V_{CC} = 1.2V$			0.3		0.3	V
		$V_{CC} = 2.0V$			0.6		0.6	
		$V_{CC} = 2.7$ to $3.6V$			0.8		0.8	
V_{OH}	HIGH level output voltage; all outputs	$V_{CC} = 1.2V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$		1.2				V
		$V_{CC} = 2.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	1.8	2.0		1.8		
		$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	2.5	2.7		2.5		
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 100\mu A$	2.8	3.0		2.8		
V_{OH}	HIGH level output voltage; STANDARD outputs	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 6mA$	2.40	2.82		2.20		V
V_{OH}	HIGH level output voltage; BUS driver outputs	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $-I_O = 8mA$	2.40	2.82		2.20		V
V_{OL}	LOW level output voltage; all outputs	$V_{CC} = 1.2V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		0				V
		$V_{CC} = 2.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		0	0.2		0.2	
		$V_{CC} = 2.7V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		0	0.2		0.2	
		$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 100\mu A$		0	0.2		0.2	
V_{OL}	LOW level output voltage; STANDARD outputs	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 6mA$		0.25	0.40		0.50	V
V_{OL}	LOW level output voltage; BUS driver outputs	$V_{CC} = 3.0V$; $V_I = V_{IH}$ or V_{IL} ; $I_O = 8mA$		0.20	0.40		0.50	V

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DC ELECTRICAL CHARACTERISTICS (Continued)

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			-40°C to +85°C			-40°C to +125°C		
			MIN	TYP ¹	MAX	MIN	MAX	
I_I	Input leakage current	$V_{CC} = 3.6\text{ V}; V_I = V_{CC}$ or GND			1.0		1.0	μA
I_{OZ}	3-State output OFF-state current	$V_{CC} = 3.6\text{ V}; V_I = V_{IH}$ or $V_{IL}; V_O = V_{CC}$ or GND			5		10	μA
I_{CC}	Quiescent supply current; SSI	$V_{CC} = 3.6\text{ V}; V_I = V_{CC}$ or GND; $I_O = 0$			20.0		40	μA
	Quiescent supply current; flip-flops	$V_{CC} = 3.6\text{ V}; V_I = V_{CC}$ or GND; $I_O = 0$			20.0		80	
	Quiescent supply current; MSI	$V_{CC} = 3.6\text{ V}; V_I = V_{CC}$ or GND; $I_O = 0$			20.0		160	μA
	Quiescent supply current; LSI	$V_{CC} = 3.6\text{ V}; V_I = V_{CC}$ or GND; $I_O = 0$			500		1000	
ΔI_{CC}	Additional quiescent supply current per input	$V_{CC} = 2.7\text{ V to }3.6\text{ V}; V_I = V_{CC} - 0.6\text{ V}$			500		850	μA

NOTE:

1. All typical values are measured at $T_{amb} = 25^\circ\text{C}$.

AC CHARACTERISTICS

GND = 0V; $t_r = t_f = 2.5\text{ ns}$; $C_L = 50\text{ pF}$; $R_L = 1\text{ k}\Omega$

SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS					UNIT
				-40 to +85 °C			-40 to +125 °C		
				MIN	TYP ¹	MAX	MIN	MAX	
t_{PHL}/t_{PLH}	Propagation delay I_n to Y	Figure 1	$V_{CC}(V)$						ns
			1.2		90				
			2.0		31	58	70		
			2.7		23	43	51		
		3.0 to 3.6		17 ²	34	41			
t_{PHL}/t_{PLH}	Propagation delay I_n to \bar{Y}	Figure 2	$V_{CC}(V)$						ns
			1.2		100				
			2.0		34	65	77		
			2.7		25	48	56		
		3.0 to 3.6		19 ²	38	45			
t_{PHL}/t_{PLH}	Propagation delay S_n to Y	Figure 1	$V_{CC}(V)$						ns
			1.2		120				
			2.0		41	77	92		
			2.7		30	56	68		
		3.0 to 3.6		23 ²	45	54			
t_{PHL}/t_{PLH}	Propagation delay S_n to \bar{Y}	Figure 2	$V_{CC}(V)$						ns
			1.2		125				
			2.0		43	82	97		
			2.7		31	60	71		
		3.0 to 3.6		24 ²	48	57			
t_{PZH}/t_{PZL}	3-State output disable time OE to Y, \bar{Y}	Figure 2	$V_{CC}(V)$						ns
			1.2		65				
			2.0		22	43	51		
			2.7		16	31	38		
		3.0 to 3.6		12 ²	25	30			
t_{PHZ}/t_{PLZ}	3-State output disable time OE to Y, \bar{Y}	Figure 2	$V_{CC}(V)$						ns
			1.2		60				
			2.0		22	39	48		
			2.7		17	29	36		
		3.0 to 3.6		13 ²	24	29			

NOTES:

1. Unless otherwise stated, all typical values are measured at $T_{amb} = 25^\circ\text{C}$ 2. Typical values are measured at $V_{CC} = 3.3\text{ V}$.

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AC WAVEFORMS

- $V_M = 1.5 \text{ V}$ at $V_{CC} \geq 2.7 \text{ V}$
- $V_M = 0.5 \text{ V} \times V_{CC}$ at $V_{CC} < 2.7 \text{ V}$
- V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.
- $V_X = V_{OL} + 0.3 \text{ V}$ at $V_{CC} \geq 2.7 \text{ V}$
- $V_X = V_{OL} + 0.1 \times V_{CC}$ at $V_{CC} < 2.7 \text{ V}$
- $V_Y = V_{OH} - 0.3 \text{ V}$ at $V_{CC} \geq 2.7 \text{ V}$
- $V_Y = V_{OH} - 0.1 \times V_{CC}$ at $V_{CC} < 2.7 \text{ V}$

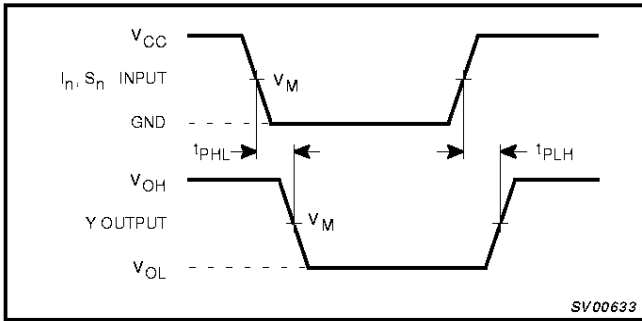


Figure 1. Multiplexer input (I_n) and select input (S_n) to output (Y) propagation delays.

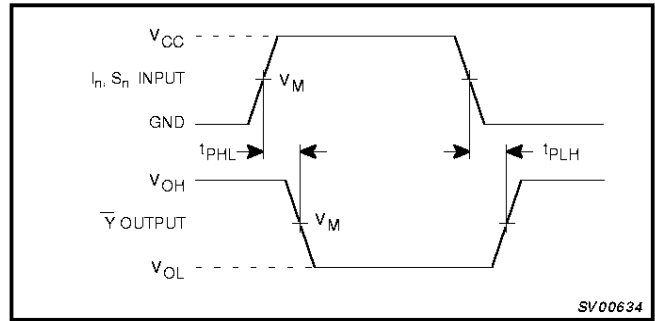


Figure 2. Multiplexer input (I_n) and the select input (S_n) to output (\bar{Y}) propagation delays.

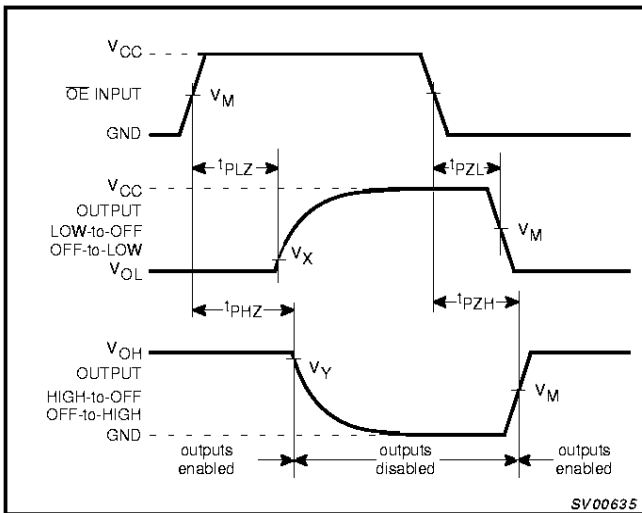


Figure 3. 3-State enable and disable times

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TEST CIRCUIT

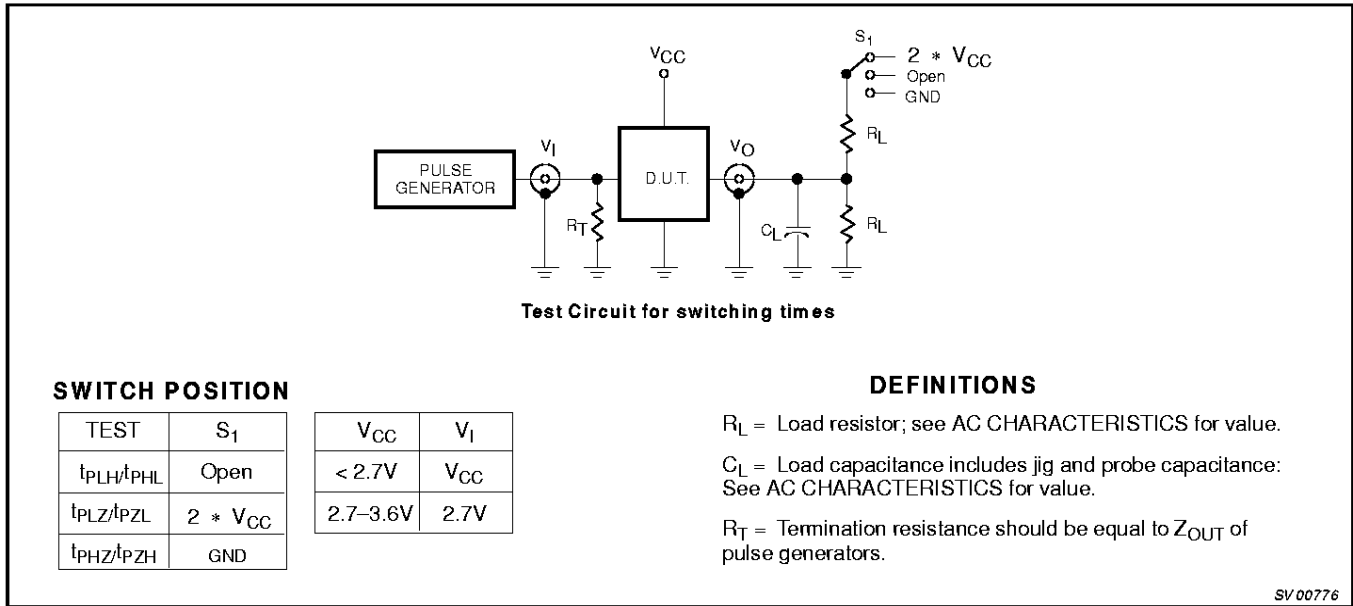


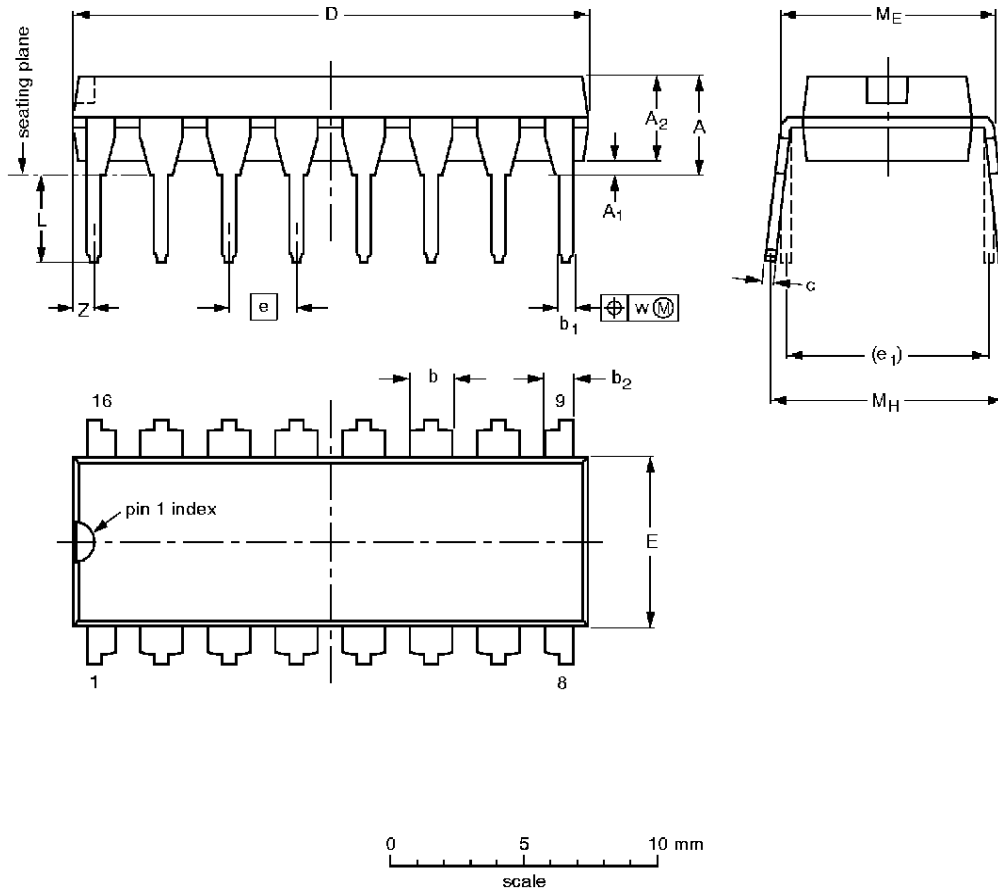
Figure 4. Load circuitry for switching times.

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DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	M _E	M _H	w	z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

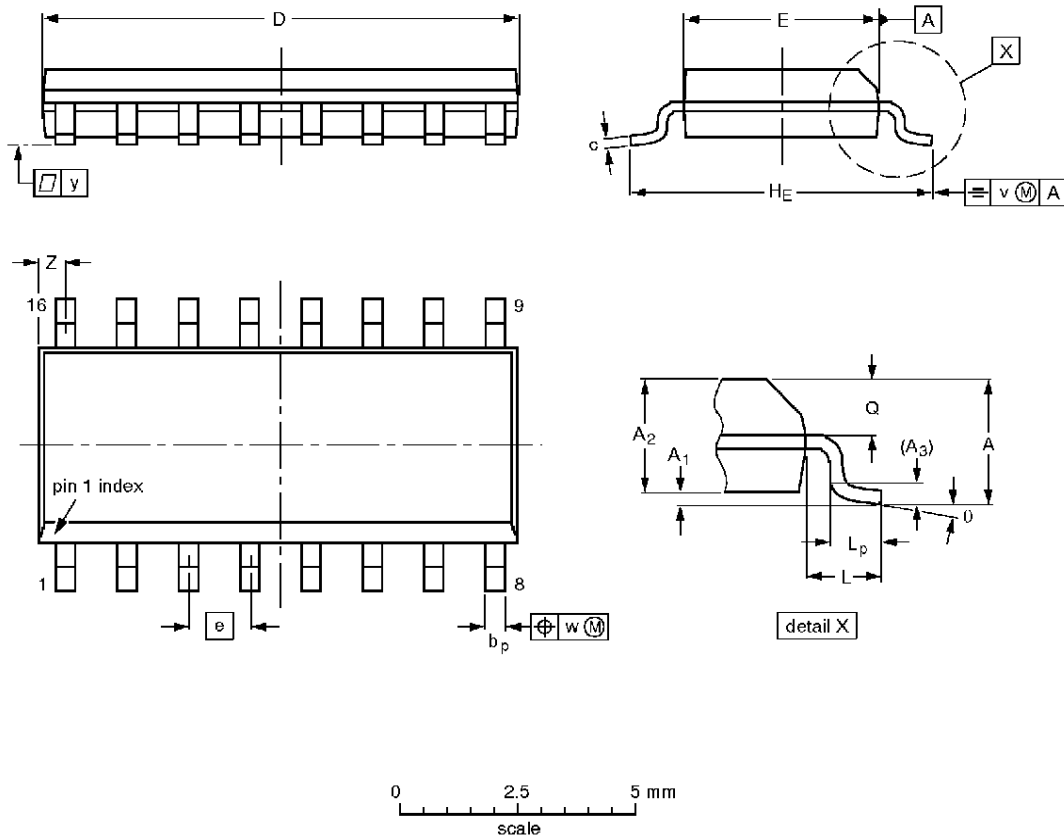
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT38-4						92-11-17 95-01-14

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SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	0
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.0098 0.0039	0.057 0.049	0.01	0.019 0.014	0.0098 0.0075	0.39 0.38	0.16 0.15	0.050	0.24 0.23	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

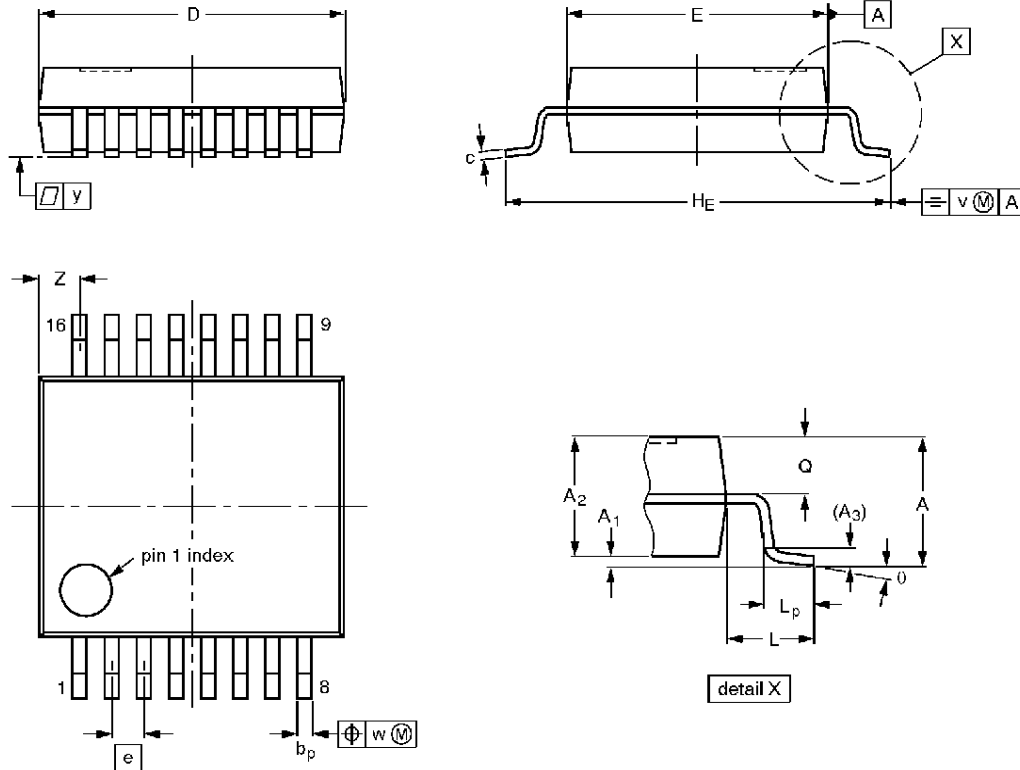
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	IEC	JEDEC	EIAJ		
SOT109-1	076E07S	MS-012AC			91-08-13 95-01-23

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SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

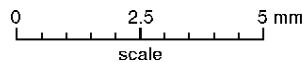
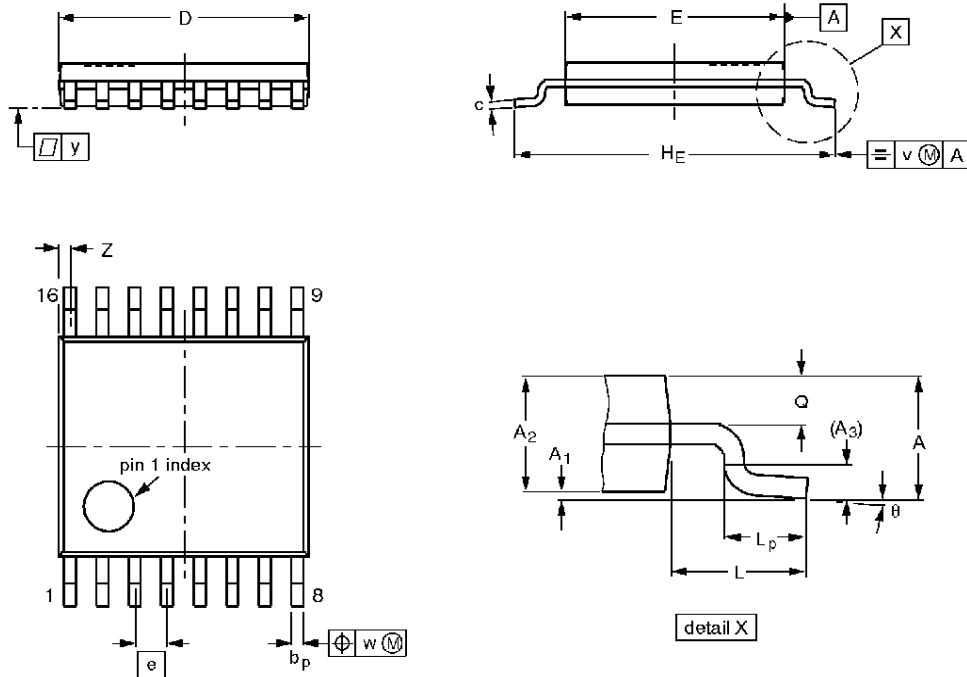
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT338-1		MO-150AC				94-01-14 95-02-04

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TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT403-1		MO-153				94-07-12 95-04-04

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DEFINITIONS

Data Sheet Identification	Product Status	Definition
<i>Objective Specification</i>	Formative or In Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.
<i>Preliminary Specification</i>	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
<i>Product Specification</i>	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.

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